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Applications of "<u>Embedded -</u> <u>Microcontrollers</u>"

#### Details

Product Status	Active
Core Processor	PIC
Core Size	8-Bit
Speed	20MHz
Connectivity	-
Peripherals	Brown-out Detect/Reset, POR, WDT
Number of I/O	13
Program Memory Size	896B (512 x 14)
Program Memory Type	ОТР
EEPROM Size	128 x 8
RAM Size	96 x 8
Voltage - Supply (Vcc/Vdd)	3V ~ 5.5V
Data Converters	-
Oscillator Type	External
Operating Temperature	-40°C ~ 85°C (TA)
Mounting Type	Through Hole
Package / Case	18-DIP (0.300", 7.62mm)
Supplier Device Package	18-PDIP
Purchase URL	https://www.e-xfl.com/product-detail/microchip-technology/pic16ce623-20i-p

Email: info@E-XFL.COM

Address: Room A, 16/F, Full Win Commercial Centre, 573 Nathan Road, Mongkok, Hong Kong

#### 2.0 PIC16CE62X DEVICE VARIETIES

A variety of frequency ranges and packaging options are available. Depending on application and production requirements the proper device option can be selected using the information in the PIC16CE62X Product Identification System section at the end of this data sheet. When placing orders, please use this page of the data sheet to specify the correct part number.

#### 2.1 UV Erasable Devices

The UV erasable version, offered in the CERDIP package is optimal for prototype development and pilot programs. This version can be erased and reprogrammed to any of the oscillator modes.

Microchip's PICSTART<sup>®</sup> and PRO MATE<sup>®</sup> programmers both support programming of the PIC16CE62X.

#### 2.2 <u>One-Time-Programmable (OTP)</u> <u>Devices</u>

The availability of OTP devices is especially useful for customers who need the flexibility for frequent code updates and small volume applications. In addition to the program memory, the configuration bits must also be programmed.

#### 2.3 <u>Quick-Turn-Programming (QTP)</u> <u>Devices</u>

Microchip offers a QTP Programming Service for factory production orders. This service is made available for users who chose not to program a medium to high quantity of units and whose code patterns have stabilized. The devices are identical to the OTP devices but with all EPROM locations and configuration options already programmed by the factory. Certain code and prototype verification procedures apply before production shipments are available. Please contact your Microchip Technology sales office for more details.

#### 2.4 <u>Serialized Quick-Turn-Programming</u> (SQTP<sup>SM</sup>) Devices

Microchip offers a unique programming service where a few user-defined locations in each device are programmed with different serial numbers. The serial numbers may be random, pseudo-random or sequential.

Serial programming allows each device to have a unique number which can serve as an entry-code, password or ID number.

#### 4.2.2 SPECIAL FUNCTION REGISTERS

The Special Function Registers are registers used by the CPU and peripheral functions for controlling the desired operation of the device (Table 4-1). These registers are static RAM. The special registers can be classified into two sets (core and peripheral). The Special Function Registers associated with the "core" functions are described in this section. Those related to the operation of the peripheral features are described in the section of that peripheral feature.

Address	Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Value on POR Reset	Value on all other resets <sup>(1)</sup>
Bank 0											
00h	INDF	Addressin register)	ig this locat	ion uses co	ontents of F	SR to addre	ess data me	emory (not a	a physical	xxxx xxxx	xxxx xxxx
01h	TMR0	Timer0 M	odule's Reg	jister						xxxx xxxx	uuuu uuuu
02h	PCL	Program (	Counter's (F	PC) Least S	Significant B	yte				0000 0000	0000 0000
03h	STATUS	IRP <sup>(2)</sup>	RP1 <sup>(2)</sup>	RP0	TO	PD	Z	DC	С	0001 1xxx	000q quuu
04h	FSR	Indirect da	ata memory	address p	ointer					xxxx xxxx	uuuu uuuu
05h	PORTA	—	—	—	RA4	RA3	RA2	RA1	RA0	x 0000	u 0000
06h	PORTB	RB7	RB6	RB5	RB4	RB3	RB2	RB1	RB0	xxxx xxxx	uuuu uuuu
07h	Unimplemented									_	-
08h	Unimplemented									-	-
09h	Unimplemented									-	-
0Ah	PCLATH	—	—	—	Write buff	er for upper	5 bits of pr	ogram cou	nter	0 0000	0 0000
0Bh	INTCON	GIE	PEIE	TOIE	INTE	RBIE	T0IF	INTF	RBIF	0000 000x	0000 000u
0Ch	PIR1	—	CMIF	—	—	—	—	_	—	-0	-0
0Dh-1Eh	Unimplemented									-	-
1Fh	CMCON	C2OUT	C10UT		—	CIS	CM2	CM1	CM0	00 0000	00 0000
Bank 1											
80h	INDF	Addressin register)	ig this locat	ion uses co	ontents of F	SR to addre	ess data me	emory (not a	a physical	XXXX XXXX	XXXX XXXX
81h	OPTION	RBPU	INTEDG	TOCS	TOSE	PSA	PS2	PS1	PS0	1111 1111	1111 1111
82h	PCL	Program (	Counter's (F	PC) Least S	Significant B	yte				0000 0000	0000 0000
83h	STATUS	IRP	RP1	RP0	TO	PD	Z	DC	С	0001 1xxx	000q quuu
84h	FSR	Indirect da	ata memory	address p	ointer					xxxx xxxx	uuuu uuuu
85h	TRISA	—	—		TRISA4	TRISA3	TRISA2	TRISA1	TRISA0	1 1111	1 1111
86h	TRISB	TRISB7	TRISB6	TRISB5	TRISB4	TRISB3	TRISB2	TRISB1	TRISB0	1111 1111	1111 1111
87h	Unimplemented									_	-
88h	Unimplemented									_	_
89h	Unimplemented									_	_
8Ah	PCLATH	—	_	_	Write buff	er for upper	5 bits of pr	ogram cou	nter	0 0000	0 0000
8Bh	INTCON	GIE	PEIE	TOIE	INTE	RBIE	T0IF	INTF	RBIF	0000 000x	0000 000u
8Ch	PIE1	—	CMIE	_	_	—	_	_	_	-0	- 0
8Dh	Unimplemented									_	_
8Eh	PCON	—	—	_	_	—	_	POR	BOD	0x	uq
8Fh-9Eh	Unimplemented									-	_
90h	EEINTF	_	—	—	—	_	EESCL	EESDA	EEVDD	111	111
9Fh	VRCON	VREN	VROE	VRR	—	VR3	VR2	VR1	VR0	000- 0000	000- 0000

#### TABLE 4-1: SPECIAL REGISTERS FOR THE PIC16CE62X

Legend: — = Unimplemented locations read as '0', u = unchanged, x = unknown, q = value depends on condition, shaded = unimplemented

Note 1: Other (non power-up) resets include MCLR reset, Brown-out Reset and Watchdog Timer Reset during normal operation.

Note 2: IRP & RPI bits are reserved; always maintain these bits clear.

#### 5.2 PORTB and TRISB Registers

PORTB is an 8-bit wide, bi-directional port. The corresponding data direction register is TRISB. A '1' in the TRISB register puts the corresponding output driver in a high impedance mode. A '0' in the TRISB register puts the contents of the output latch on the selected pin(s).

Reading PORTB register reads the status of the pins, whereas writing to it will write to the port latch. All write operations are read-modify-write operations. So a write to a port implies that the port pins are first read, then this value is modified and written to the port data latch.

Each of the PORTB pins has a weak internal pull-up ( $\approx 200 \ \mu A$  typical). A single control bit can turn on all the pull-ups. This is done by clearing the  $\overline{RBPU}$  (OPTION<7>) bit. The weak pull-up is automatically turned off when the port pin is configured as an output. The pull-ups are disabled on Power-on Reset.

Four of PORTB's pins, RB<7:4>, have an interrupt on change feature. Only pins configured as inputs can cause this interrupt to occur (i.e., any RB<7:4> pin configured as an output is excluded from the interrupt on change comparison). The input pins of RB<7:4> are compared with the old value latched on the last read of PORTB. The "mismatch" outputs of RB<7:4> are OR'ed together to generate the RBIF interrupt (flag latched in INTCON<0>).





This interrupt can wake the device from SLEEP. The user, in the interrupt service routine, can clear the interrupt in the following manner:

- a) Any read or write of PORTB. This will end the mismatch condition.
- b) Clear flag bit RBIF.

A mismatch condition will continue to set flag bit RBIF. Reading PORTB will end the mismatch condition and allow flag bit RBIF to be cleared.

This interrupt on mismatch feature, together with software configurable pull-ups on these four pins allow easy interface to a key pad and make it possible for wake-up on key-depression. (See AN552, "Implementing Wake-Up on Key Strokes".)

Note:	If a change on the I/O pin should occur
	when the read operation is being executed
	(start of the Q2 cycle), then the RBIF inter-
	rupt flag may not get set.

The interrupt on change feature is recommended for wake-up on key depression operation and operations where PORTB is only used for the interrupt on change feature. Polling of PORTB is not recommended while using the interrupt on change feature.





#### 6.1 Bus Characteristics

In this section, the term "processor" refers to the portion of the PIC16CE62X that interfaces to the EEPROM through software manipulating the EEINTF register. The following **bus protocol** is to be used with the EEPROM data memory.

- Data transfer may be initiated only when the bus is not busy.
- During data transfer, the data line must remain stable whenever the clock line is HIGH. Changes in the data line while the clock line is HIGH will be interpreted by the EEPROM as a START or STOP condition.

Accordingly, the following bus conditions have been defined (Figure 6-1).

#### 6.1.1 BUS NOT BUSY (A)

Both data and clock lines remain HIGH.

#### 6.1.2 START DATA TRANSFER (B)

A HIGH to LOW transition of the SDA line while the clock (SCL) is HIGH determines a START condition. All commands must be preceded by a START condition.

#### 6.1.3 STOP DATA TRANSFER (C)

A LOW to HIGH transition of the SDA line while the clock (SCL) is HIGH determines a STOP condition. All operations must be ended with a STOP condition.

#### 6.1.4 DATA VALID (D)

The state of the data line represents valid data when, after a START condition, the data line is stable for the duration of the HIGH period of the clock signal.

The data on the line must be changed during the LOW period of the clock signal. There is one bit of data per clock pulse.

Each data transfer is initiated with a START condition and terminated with a STOP condition. The number of the data bytes transferred between the START and STOP conditions is determined by the processor and is theoretically unlimited, although only the last sixteen will be stored when doing a write operation. When an overwrite does occur, it will replace data in a first-in, first-out fashion.

#### 6.1.5 ACKNOWLEDGE

The EEPROM will generate an acknowledge after the reception of each byte. The processor must generate an extra clock pulse which is associated with this acknowledge bit.

Note:	Acknowledge bits are not generated if an
	internal programming cycle is in progress.

When the EEPROM acknowledges, it pulls down the SDA line during the acknowledge clock pulse in such a way that the SDA line is stable LOW during the HIGH period of the acknowledge related clock pulse. Of course, setup and hold times must be taken into account. The processor must signal an end of data to the EEPROM by not generating an acknowledge bit on the last byte that has been clocked out of the EEPROM. In this case, the EEPROM must leave the data line HIGH to enable the processor to generate the STOP condition (Figure 6-2).







#### 6.2 Device Addressing

After generating a START condition, the processor transmits a control byte consisting of a EEPROM address and a Read/Write bit that indicates what type of operation is to be performed. The EEPROM address consists of a 4-bit device code (1010) followed by three don't care bits.

The last bit of the control byte determines the operation to be performed. When set to a one, a read operation is selected, and when set to a zero, a write operation is selected. (Figure 6-3). The bus is monitored for its corresponding EEPROM address all the time. It generates an acknowledge bit if the EEPROM address was true and it is not in a programming mode.

#### FIGURE 6-3: CONTROL BYTE FORMAT



#### 10.2 Oscillator Configurations

#### 10.2.1 OSCILLATOR TYPES

The PIC16CE62X can be operated in four different oscillator options. The user can program two configuration bits (FOSC1 and FOSC0) to select one of these four modes:

- LP Low Power Crystal
- XT Crystal/Resonator
- HS High Speed Crystal/Resonator
- RC Resistor/Capacitor

### 10.2.2 CRYSTAL OSCILLATOR / CERAMIC RESONATORS

In XT, LP or HS modes, a crystal or ceramic resonator is connected to the OSC1 and OSC2 pins to establish oscillation (Figure 10-1). The PIC16CE62X oscillator design requires the use of a parallel cut crystal. Use of a series cut crystal may give a frequency out of the crystal manufacturers specifications. When in XT, LP or HS modes, the device can have an external clock source to drive the OSC1 pin (Figure 10-2).

#### FIGURE 10-1: CRYSTAL OPERATION (OR CERAMIC RESONATOR) (HS, XT OR LP OSC CONFIGURATION)



See Table 10-1 and Table 10-2 for recommended values of C1 and C2.

Note: A series resistor may be required for AT strip cut crystals.

#### FIGURE 10-2: EXTERNAL CLOCK INPUT OPERATION (HS, XT OR LP OSC CONFIGURATION)



#### TABLE 10-1: CERAMIC RESONATORS, PIC16CE62X

**Ranges Tested:** OSC2 Mode Freq OSC1 XT 455 kHz 68 - 100 pF 68 - 100 pF 15 - 68 pF 15 - 68 pF 2.0 MHz 4.0 MHz 15 - 68 pF 15 - 68 pF HS 10 - 68 pF 10 - 68 pF 8.0 MHz 16.0 MHz 10 - 22 pF 10 - 22 pF

These values are for design guidance only. See notes at bottom of page.

#### TABLE 10-2: CAPACITOR SELECTION FOR CRYSTAL OSCILLATOR, PIC16CE62X

Osc Type	Crystal Freq	Cap. Range C1	Cap. Range C2
LP	32 kHz	33 pF	33 pF
	200 kHz	15 pF	15 pF
XT	200 kHz	47-68 pF	47-68 pF
	1 MHz	15 pF	15 pF
	4 MHz	15 pF	15 pF
HS	4 MHz	15 pF	15 pF
	8 MHz	15-33 pF	15-33 pF
	20 MHz	15-33 pF	15-33 pF

These values are for design guidance only. See notes at bottom of page.

- 1. Recommended values of C1 and C2 are identical to the ranges tested table.
- 2. Higher capacitance increases the stability of oscillator, but also increases the start-up time.
- 3. Since each resonator/crystal has its own characteristics, the user should consult the resonator/crystal manufacturer for appropriate values of external components.
- 4. Rs may be required in HS mode, as well as XT mode, to avoid overdriving crystals with low drive level specification.

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#### 10.4 <u>Power-on Reset (POR), Power-up</u> <u>Timer (PWRT), Oscillator Start-up</u> <u>Timer (OST) and Brown-out Reset</u> (BOD)

#### 10.4.1 POWER-ON RESET (POR)

The on-chip POR circuit holds the chip in reset until VDD has reached a high enough level for proper operation. To take advantage of the POR, just tie the  $\overline{\text{MCLR}}$  pin through a resistor to VDD. This will eliminate external RC components usually needed to create Power-on Reset. A maximum rise time for VDD is required. See electrical specifications for details.

The POR circuit does not produce an internal reset when VDD declines.

When the device starts normal operation (exits the reset condition), device operating parameters (voltage, frequency, temperature, etc.) must be met to ensure operation. If these conditions are not met, the device must be held in reset until the operating conditions are met.

For additional information, refer to Application Note AN607, "Power-up Trouble Shooting".

#### 10.4.2 POWER-UP TIMER (PWRT)

The Power-up Timer provides a fixed 72 ms (nominal) time-out on power-up only, from POR or Brown-out Reset. The Power-up Timer operates on an internal RC oscillator. The chip is kept in reset as long as PWRT is active. The PWRT delay allows the VDD to rise to an acceptable level. A configuration bit, PWRTE, can disable (if set) or enable (if cleared or programmed) the Power-up Timer. The Power-up Timer should always be enabled when Brown-out Reset is enabled.

The Power-Up Time delay will vary from chip-to-chip and due to VDD, temperature and process variation. See DC parameters for details.

#### 10.4.3 OSCILLATOR START-UP TIMER (OST)

The Oscillator Start-Up Timer (OST) provides a 1024 oscillator cycle (from OSC1 input) delay after the PWRT delay is over. This ensures that the crystal oscillator or resonator has started and stabilized.

The OST time-out is invoked only for XT, LP and HS modes and only on power-on reset or wake-up from SLEEP.

#### 10.4.4 BROWN-OUT RESET (BOD)

The PIC16CE62X members have on-chip Brown-out Reset circuitry. A configuration bit, BOREN, can disable (if clear/programmed) or enable (if set) the Brown-out Reset circuitry. If VDD falls below 4.0V (refer to BVDD parameter D005) for greater than parameter (TBOR) in Table 13-5, the brown-out situation will reset the chip. A reset won't occur if VDD falls below 4.0V for less than parameter (TBOR).

On any reset (Power-on, Brown-out, Watch-dog, etc.) the chip will remain in reset until VDD rises above BVDD. The Power-up Timer will then be invoked and will keep the chip in reset an additional 72 ms.

If VDD drops below BVDD while the Power-up Timer is running, the chip will go back into a Brown-out Reset and the Power-up Timer will be re-initialized. Once VDD rises above BVDD, the Power-Up Timer will execute a 72 ms reset. The Power-up Timer should always be enabled when Brown-out Reset is enabled. Figure 10-7 shows typical Brown-out situations.



#### FIGURE 10-7: BROWN-OUT SITUATIONS

#### 10.6 Context Saving During Interrupts

During an interrupt, only the return PC value is saved on the stack. Typically, users may wish to save key registers during an interrupt (i.e. W register and STATUS register). This will have to be implemented in software.

Example 10-1 stores and restores the STATUS and W registers. The user register, W\_TEMP, must be defined in both banks and must be defined at the same offset from the bank base address (i.e., W\_TEMP is defined at 0x70 in Bank 0 and it must also be defined at 0xF0 in Bank 1). The user register, STATUS\_TEMP, must be defined in Bank 0. The Example 10-1:

- Stores the W register
- Stores the STATUS register in Bank 0
- Executes the ISR code
- Restores the STATUS (and bank select bit register)
- · Restores the W register

#### EXAMPLE 10-1: SAVING THE STATUS AND W REGISTERS IN RAM

MOVWF	W_TEMP	;copy W to temp register, ;could be in either bank
SWAPF	STATUS,W	;swap status to be saved into $\ensuremath{\mathtt{W}}$
BCF	STATUS, RPO	;change to bank 0 regardless ;of current bank
MOVWF	STATUS_TEMP	;save status to bank 0 ;register
:		
:	(ISR)	
:		
SWAPF	STATUS_TEMP,W	;swap STATUS_TEMP register ;into W, sets bank to original ;state
MOVWF	STATUS	;move W into STATUS register
SWAPF	W_TEMP,F	;swap W_TEMP
SWAPF	W_TEMP,W	;swap W_TEMP into W

#### 10.7 <u>Watchdog Timer (WDT)</u>

The Watchdog Timer is a free running on-chip RC oscillator which does not require any external components. This RC oscillator is separate from the RC oscillator of the CLKIN pin. That means that the WDT will run, even if the clock on the OSC1 and OSC2 pins of the device have been stopped, for example, by execution of a SLEEP instruction. During normal operation, a WDT time-out generates a device RESET. If the device is in SLEEP mode, a WDT time-out causes the device to wake-up and continue with normal operation. The WDT can be permanently disabled by programming the configuration bit WDTE as clear (Section 10.1).

#### 10.7.1 WDT PERIOD

The WDT has a nominal time-out period of 18 ms, (with no prescaler). The time-out periods vary with temperature, VDD and process variations from part to part (see DC specs). If longer time-out periods are desired, a prescaler with a division ratio of up to 1:128 can be assigned to the WDT under software control by writing to the OPTION register. Thus, time-out periods up to 2.3 seconds can be realized.

The CLRWDT and SLEEP instructions clear the WDT and the postscaler, if assigned to the WDT, and prevent it from timing out and generating a device RESET.

The  $\overline{\text{TO}}$  bit in the STATUS register will be cleared upon a Watchdog Timer time-out.

#### 10.7.2 WDT PROGRAMMING CONSIDERATIONS

It should also be taken in account that under worst case conditions (VDD = Min., Temperature = Max., max. WDT prescaler), it may take several seconds before a WDT time-out occurs.

### 11.0 INSTRUCTION SET SUMMARY

Each PIC16CE62X instruction is a 14-bit word divided into an OPCODE which specifies the instruction type and one or more operands which further specify the operation of the instruction. The PIC16CE62X instruction set summary in Table 11-2 lists **byte-oriented**, **bit-oriented**, and **literal and control** operations. Table 11-1 shows the opcode field descriptions.

For **byte-oriented** instructions, 'f' represents a file register designator and 'd' represents a destination designator. The file register designator specifies which file register is to be used by the instruction.

The destination designator specifies where the result of the operation is to be placed. If 'd' is zero, the result is placed in the W register. If 'd' is one, the result is placed in the file register specified in the instruction.

For **bit-oriented** instructions, 'b' represents a bit field designator which selects the number of the bit affected by the operation, while 'f' represents the number of the file in which the bit is located.

For **literal and control** operations, 'k' represents an eight or eleven bit constant or literal value.

#### TABLE 11-1: OPCODE FIELD DESCRIPTIONS

Field	Description
f	Register file address (0x00 to 0x7F)
W	Working register (accumulator)
b	Bit address within an 8-bit file register
k	Literal field, constant data or label
x	Don't care location (= 0 or 1) The assembler will generate code with $x = 0$ . It is the recommended form of use for compatibility with all Microchip software tools.
d	Destination select; d = 0: store result in W, d = 1: store result in file register f. Default is d = 1
label	Label name
TOS	Top of Stack
PC	Program Counter
PCLATH	Program Counter High Latch
GIE	Global Interrupt Enable bit
WDT	Watchdog Timer/Counter
TO	Time-out bit
PD	Power-down bit
dest	Destination either the W register or the specified register file location
[]	Options
()	Contents
$\rightarrow$	Assigned to
<>	Register bit field
∈	In the set of
italics	User defined term (font is courier)

The instruction set is highly orthogonal and is grouped into three basic categories:

- Byte-oriented operations
- Bit-oriented operations
- Literal and control operations

All instructions are executed within one single instruction cycle, unless a conditional test is true or the program counter is changed as a result of an instruction. In this case, the execution takes two instruction cycles with the second cycle executed as a NOP. One instruction cycle consists of four oscillator periods. Thus, for an oscillator frequency of 4 MHz, the normal instruction execution time is 1  $\mu$ s. If a conditional test is true or the program counter is changed as a result of an instruction, the instruction execution time is 2  $\mu$ s.

Table 11-1 lists the instructions recognized by the MPASM assembler.

Figure 11-1 shows the three general formats that the instructions can have.

Note:	То	maintain	upward	compatibility	with
	futu	ire PIC <sup>®</sup> M	ICU produ	ucts, <u>do not us</u>	<u>e</u> the
	OP	TION and 1	TRIS inst	ructions.	

All examples use the following format to represent a hexadecimal number:

0xhh

where h signifies a hexadecimal digit.

### FIGURE 11-1: GENERAL FORMAT FOR INSTRUCTIONS



<sup>13 11 10</sup> OPCODE k (literal)

k = 11-bit immediate value

NOP	No Operation				
Syntax:	[ label ]	NOP			
Operands:	None				
Operation:	No operation				
Status Affected:	None				
Encoding:	0 0	0000	0xx0	0000	
Description:	No operati	ion.			
Words:	1				
Cycles:	1				
Example	NOP				

RETFIE	Return from Interrupt	
Syntax:	[label] RETFIE	
Operands:	None	
Operation:	$\begin{array}{l} TOS \to PC, \\ 1 \to GIE \end{array}$	
Status Affected:	None	
Encoding:	00 0000 0000 1001	
Description:	Return from Interrupt. Stack is POPed and Top of Stack (TOS) is loaded in the PC. Interrupts are enabled by setting Global Interrupt Enable bit, GIE (INTCON<7>). This is a two-cycle instruction.	
Words:	1	
Cycles:	2	
Example	RETFIE	
	After Interrupt PC = TOS GIE = 1	

OPTION	Load Option Register
Syntax:	[label] OPTION
Operands:	None
Operation:	$(W) \rightarrow OPTION$
Status Affected:	None
Encoding:	00 0000 0110 0010
Description: Words:	The contents of the W register are loaded in the OPTION register. This instruction is supported for code compatibility with PIC16C5X products. Since OPTION is a readable/writable register, the user can directly address it.
Cycles: Example	1
	To maintain upward compatibility with future PIC <sup>®</sup> MCU products, do not use this instruction.

RETLW	Return with Literal in W
Syntax:	[ <i>label</i> ] RETLW k
Operands:	$0 \le k \le 255$
Operation:	$k \rightarrow (W);$ TOS $\rightarrow$ PC
Status Affected:	None
Encoding:	11 01xx kkkk kkkk
Description:	The W register is loaded with the eight bit literal 'k'. The program counter is loaded from the top of the stack (the return address). This is a two-cycle instruction.
Words:	1
Cycles:	2
Example	CALL TABLE ;W contains table ;offset value ;W now has table value
TABLE	ADDWF PC ;W = offset RETLW k1 ;Begin table RETLW k2 ; • RETLW kn ; End of table
	Before Instruction
	W = 0x07 After Instruction
	W = value of k8

RETURN	Return from Subroutine	RRF	Rotate Right f through Carry
Syntax:	[label] RETURN	Syntax:	[ <i>label</i> ] RRF f,d
Operands:	None	Operands:	$0 \leq f \leq 127$
Operation:	$TOS \rightarrow PC$		$d \in [0,1]$
Status Affected:	None	Operation:	See description below
Encoding:	00 0000 0000 1000	Status Affected:	С
Description:	Return from subroutine. The stack is	Encoding:	00 1100 dfff ffff
Words:	POPed and the top of the stack (TOS) is loaded into the program counter. This is a two cycle instruction. 1	Description:	The contents of register 'f' are rotated one bit to the right through the Carry Flag. If 'd' is 0, the result is placed in the W register. If 'd' is 1, the result is placed back in register 'f'
Cycles:	2		
Example	RETURN		
	After Interrupt	Words:	1
	PC = TOS	Cycles:	1
		Example	RRF REG1,0
			Before Instruction
			REG1 = 1110 0110 C = 0
			After Instruction
			$\begin{array}{rcl} \mathbf{REG1} &=& 1110 & 0110 \\ \mathbf{W} &=& 0111 & 0011 \end{array}$
			C = 0

RLF	Rotate I	_eft f thr	ough	Carr	у		
Syntax:	[ label ]	RLF	f,d				
Operands:	$0 \le f \le 1$ $d \in [0,1]$	27					
Operation:	See des	cription I	oelow				
Status Affected:	С						
Encoding:	00	1101	dff	f	ffff		
	one bit to Flag. If 'd the W reg stored ba	one bit to the left through the Carry Flag. If 'd' is 0, the result is placed in the W register. If 'd' is 1, the result is stored back in register 'f'.					
Words:	1						
Cycles:	1						
Example	RLF	RE	G1,0				
	Before II	Before Instruction					
		REG1	=	1110	0110		
	After Inc	C	=	0			
	Alterins	Infraction					
		DEC1		1110	0110		
		REG1 W	= :	1110	0110		

### SLEEP

Syntax:	[ label ]	SLEEP	)		
Operands:	None				
Operation:	$\begin{array}{l} 00h \rightarrow WDT, \\ 0 \rightarrow WDT \ \text{prescaler}, \\ 1 \rightarrow \overline{TO}, \\ 0 \rightarrow \overline{PD} \end{array}$				
Status Affected:	TO, PD				
Encoding:	0 0	0000	0110	0011	
Description:	The power-down status bit, PD is cleared. Time-out status bit, TO is set. Watchdog Timer and its prescaler are cleared. The processor is put into SLEEP mode with the oscillator stopped. See Section 10.8 for more details.				
Words:	1				
Cycles:	1				
Example:	SLEEP				

SUBLW	Subtract W from Literal	SUBWF	Subtract W from f
Syntax:	[ <i>label</i> ] SUBLW k	Syntax:	[ <i>label</i> ] SUBWF f,d
Operands:	$0 \le k \le 255$	Operands:	$0 \le f \le 127$
Operation:	$k - (W) \rightarrow (W)$		d ∈ [0,1]
Status Affected:	C, DC, Z	Operation: Status	(f) - (W) $\rightarrow$ (dest) C, DC, Z
Encoding:	11 110x kkkk kkkk	Affected:	
Description:	The W register is subtracted (2's com- plement method) from the eight bit literal 'k'. The result is placed in the W register.	Encoding: Description:	00         0010         dfff         ffff           Subtract (2's complement method)         W register from register 'f'. If 'd' is 0, the
Words:	1		result is stored in the W register. If 'd' is 1,
Cycles:	1	Words <sup>.</sup>	1
Example 1:	SUBLW 0x02	Cycles:	1
	Before Instruction	Example 1	SUBWE REG1 1
	W = 1 $C = ?$		Before Instruction
	After Instruction W = 1 C = 1; result is positive		REG1 = 3 W = 2 C = ?
Example 2:	Before Instruction		After Instruction
	W = 2 C = ?		REG1 = 1 W = 2 C = 1; result is positive
	After Instruction	Example 2:	Before Instruction
Example 3:	W = 0 C = 1; result is zero Before Instruction		REG1 = 2 W = 2 C = ?
	W = 3		After Instruction
	C = ? After Instruction		REG1 = 0 W = 2 C = 1; result is zero
	VV = 0XFF C = 0; result is nega-	Example 3:	Before Instruction
	tive		REG1 = 1 W = 2 C = ?
			After Instruction
			REG1 = 0xFF W = 2 C = 0; result is negative





**2:** The maximum rated speed of the part limits the permissible combinations of voltage and frequency. Please reference the Product Identification System section for the maximum rated speed of the parts.







#### 13.3 DC CHARACTERISTICS:

#### PIC16CE62X-04 (Commercial, Industrial, Extended) PIC16CE62X-20 (Commercial, Industrial, Extended) PIC16LCE62X (Commercial, Industrial)

			Standard Opera	ting C	Conditions (u	Inles	s otherwise stated)
			Operating tempe	rature	_40°C ≤	TA≤	+85°C for industrial and
DC CHARACTERISTICS					0°C ≤	TA≤	+70°C for commercial and
					–40°C ≤	TA≤	+125°C for extended
Operating voltage VDD range as described in DC spec Table 13-1						ed in DC spec Table 13-1	
Parm	Sym	Characteristic	Min	Typ†	Max	Unit	Conditions
No.							
	Vi∟	Input Low Voltage					
		I/O ports					
D030		with TTL buffer	Vss	-	0.8V	V	VDD = 4.5V to 5.5V, Otherwise
Dood			1/22		0.15VDD		
D031		with Schmitt Trigger input	VSS		0.2VDD	V	
D032		mode)	VSS	-	0.2VDD	V	Note1
D033		OSC1 (in XT and HS)	Vss	_	0.3VDD	V	
		OSC1 (in LP)	Vss	-	0.6Vdd - 1.0	V	
	VIH	Input High Voltage					
		I/O ports					
D040		with TTL buffer	2.0V	-	Vdd	V	VDD = 4.5V to 5.5V, Otherwise
			.25VDD + 0.8V		Vdd		
D041		with Schmitt Trigger input	0.8VDD		Vdd		
D042		MCLR RA4/T0CKI	0.8VDD	-	Vdd	V	
D043		OSC1 (XT, HS and LP)	0.7Vdd	-	Vdd	V	
D043A		OSC1 (in RC mode)	0.9Vdd				Note1
D070	IPURB	PORTB weak pull-up current	50	200	400	μA	VDD = 5.0V, VPIN = VSS
		Input Leakage Current					
	IIL	(Notes 2, 3)					
Daga		I/O ports (Except PORIA)			±1.0	μA	VSS $\leq$ VPIN $\leq$ VDD, pin at hi-impedance
D060		PORTA	-	-	±0.5	μA	Vss $\leq$ VPIN $\leq$ VDD, pin at hi-impedance
D061		RA4/IOCKI	-	-	±1.0	μA	$VSS \leq VPIN \leq VDD$
D063		OSC1, MCLR	-	-	±5.0	μA	Vss $\leq$ VPIN $\leq$ VDD, XT, HS and LP osc
	Mai	Output Law Valtage					configuration
D000	VOL				0.0		
D080		I/O ports	-	_	0.6	v	$IOL=8.5 \text{ mA}, \text{ VDD}=4.5 \text{ V}, -40^{\circ} \text{ to } +85^{\circ}\text{ C}$
Daga			-	-	0.6	V	IOL=7.0 mA, VDD=4.5V, +125°C
D083		OSC2/CLKOUT (RC only)	-	-	0.6	V	$IOL=1.6 \text{ mA}, VDD=4.5V, -40^{\circ} \text{ to } +85^{\circ}\text{C}$
	Mari	Output Link Valtage (Nata 0)	-	-	0.6	V	IOL=1.2 MA, VDD=4.5V, +125°C
D000	VOH					v	
D090		I/O ports (Except RA4)		_	-	V	$10H = -3.0 \text{ mA}, \text{ VDD} = 4.5 \text{ V}, -40^{-1} \text{ 10} +85^{-1} \text{ C}$
D000				_	-	v	10H = -2.5  IIIA, VDD = 4.5 V, +125 C
D092		OSC2/CLKOUT (RC only)		_	_	V	IOH=-1.3 MA, VDD=4.5V, -40° to +85°C
*D150	Von	Open-Drain High Voltage	VDD-0.7	_	- 85	V	IOH=-1.0 IIIA, VDD=4.5V, +125 C
0100	000	Canacitive Loading Space on			0.0	v	וווק דרער
		Output Pins					
D100	cosc	OSC2 pin			15	рF	In XT. HS and LP modes when external
	2	r			-		clock used to drive OSC1.
D101	Cio	All I/O pins/OSC2 (in RC mode)			50	pF	

These parameters are characterized but not tested.

† Data in "Typ" column is at 5.0V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

**Note 1:** In RC oscillator configuration, the OSC1 pin is a Schmitt Trigger input. It is not recommended that the PIC16CE62X be driven with external clock in RC mode.

2: The leakage current on the MCLR pin is strongly dependent on applied voltage level. The specified levels represent normal operating conditions. Higher leakage current may be measured at different input voltages.

3: Negative current is defined as coming out of the pin.

#### FIGURE 13-7: RESET, WATCHDOG TIMER, OSCILLATOR START-UP TIMER AND POWER-UP TIMER TIMING



#### FIGURE 13-8: BROWN-OUT RESET TIMING



#### **TABLE 13-5:** RESET, WATCHDOG TIMER, OSCILLATOR START-UP TIMER AND POWER-UP TIMER REQUIREMENTS

Parameter	Sym	Characteristic	Min	Тур†	Max	Units	Conditions
No.							
30	TmcL	MCLR Pulse Width (low)	2000	_		ns	-40° to +85°C
31	Twdt	Watchdog Timer Time-out Period (No Prescaler)	7*	18	33*	ms	$VDD = 5.0V, -40^{\circ} \text{ to } +85^{\circ}C$
32	Tost	Oscillation Start-up Timer Period		1024 Tosc		_	Tosc = OSC1 period
33	Tpwrt	Power-up Timer Period	28*	72	132*	ms	$VDD = 5.0V, -40^{\circ} \text{ to } +85^{\circ}C$
34	Tioz	I/O hi-impedance from MCLR low			2.0	μs	
35	TBOR	Brown-out Reset Pulse Width	100*	_		μs	$3.7V \leq V\text{DD} \leq 4.3V$

These parameters are characterized but not tested. Data in "Typ" column is at 5.0V, 25°C unless otherwise stated. These parameters are for design guidance only and are t not tested.

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